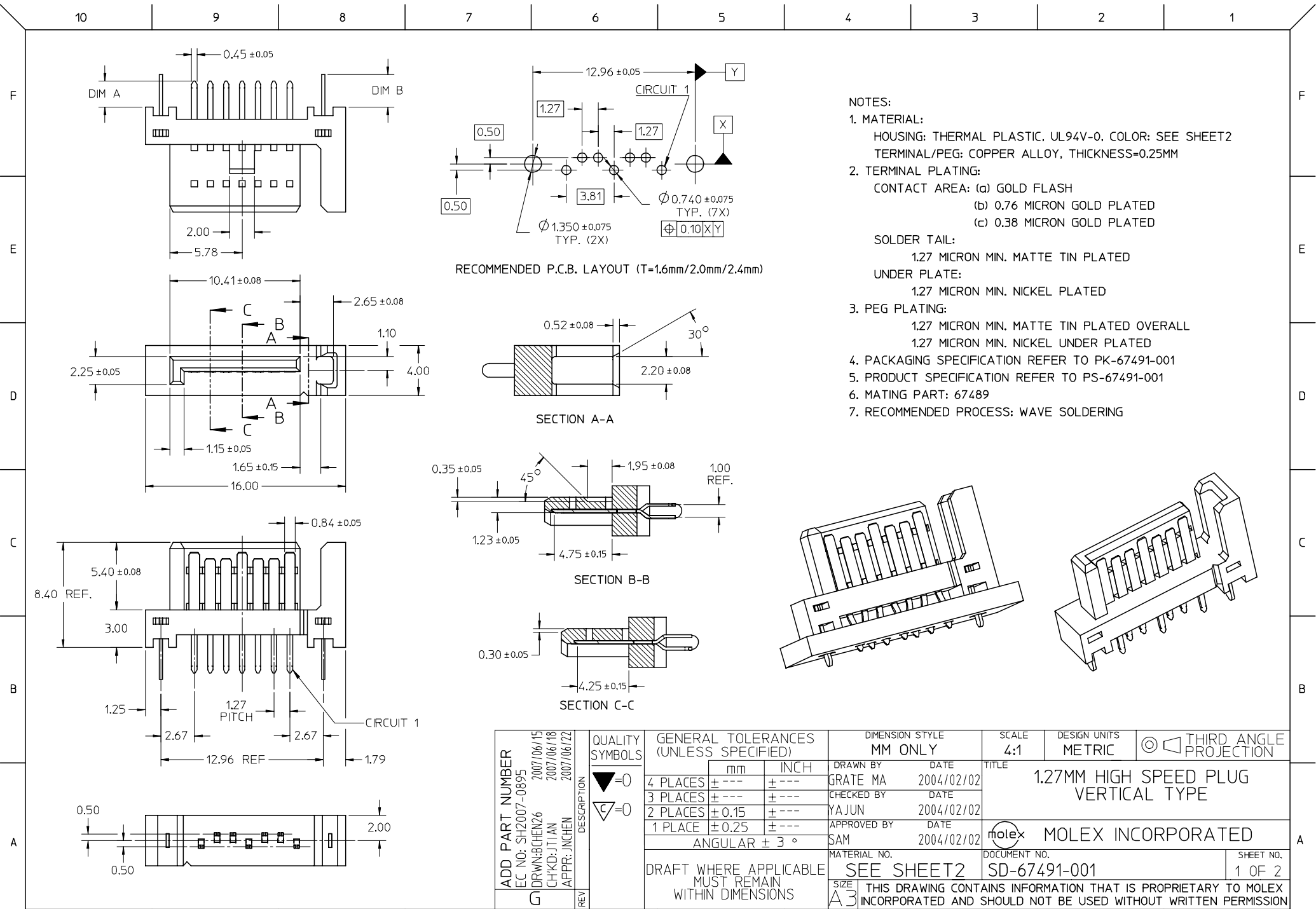




NOTES:

1. MATERIAL:

HOUSING: THERMAL PLASTIC, UL94V-0, COLOR: SEE SHEET2
TERMINAL/PEG: COPPER ALLOY, THICKNESS=0.25MM

2. TERMINAL PLATING:

CONTACT AREA: (a) GOLD FLASH
(b) 0.76 MICRON GOLD PLATED
(c) 0.38 MICRON GOLD PLATED

SOLDER TAIL:

1.27 MICRON MIN. MATTE TIN PLATED

UNDER PLATE:

1.27 MICRON MIN. NICKEL PLATED

3. PEG PLATING:

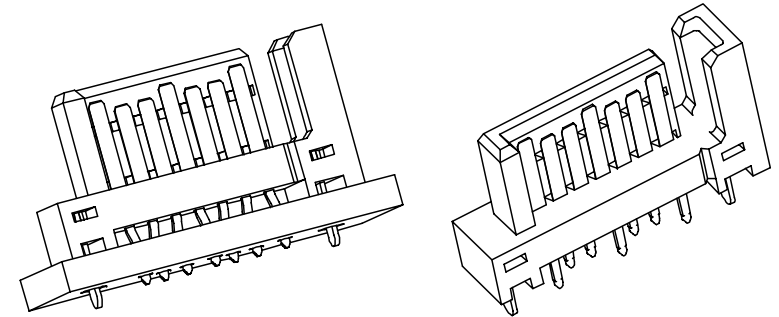
1.27 MICRON MIN. MATTE TIN PLATED OVERALL
1.27 MICRON MIN. NICKEL UNDER PLATED

4. PACKAGING SPECIFICATION REFER TO PK-67491-001

5. PRODUCT SPECIFICATION REFER TO PS-67491-001

6. MATING PART: 67489

7. RECOMMENDED PROCESS: WAVE SOLDERING



ADD PART NUMBER EC NO: SH2007-0895 DRWN: CHENZ6 CHKD: JTIAN APPR: INCHEM		2007/06/15 2007/06/18 2007/06/22	DESCRIPTION	REV	QUALITY SYMBOLS ▽=0 ▽C=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION 			
							mm	INCH	DRAWN BY DATE		TITLE				
						4 PLACES	± ---	± ---	GRATE MA	2004/02/02	1.27MM HIGH SPEED PLUG VERTICAL TYPE				
						3 PLACES	± ---	± ---	CHECKED BY	DATE					
						2 PLACES	± 0.15	± ---	YA JUN	2004/02/02	MOLEX INCORPORATED				
						1 PLACE	± 0.25	± ---	APPROVED BY	DATE					
						ANGULAR ± 3 °			SAM	2004/02/02	MOLEX				
						DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
									SEE SHEET2		SD-67491-001		1 OF 2		
						SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

[illegible]